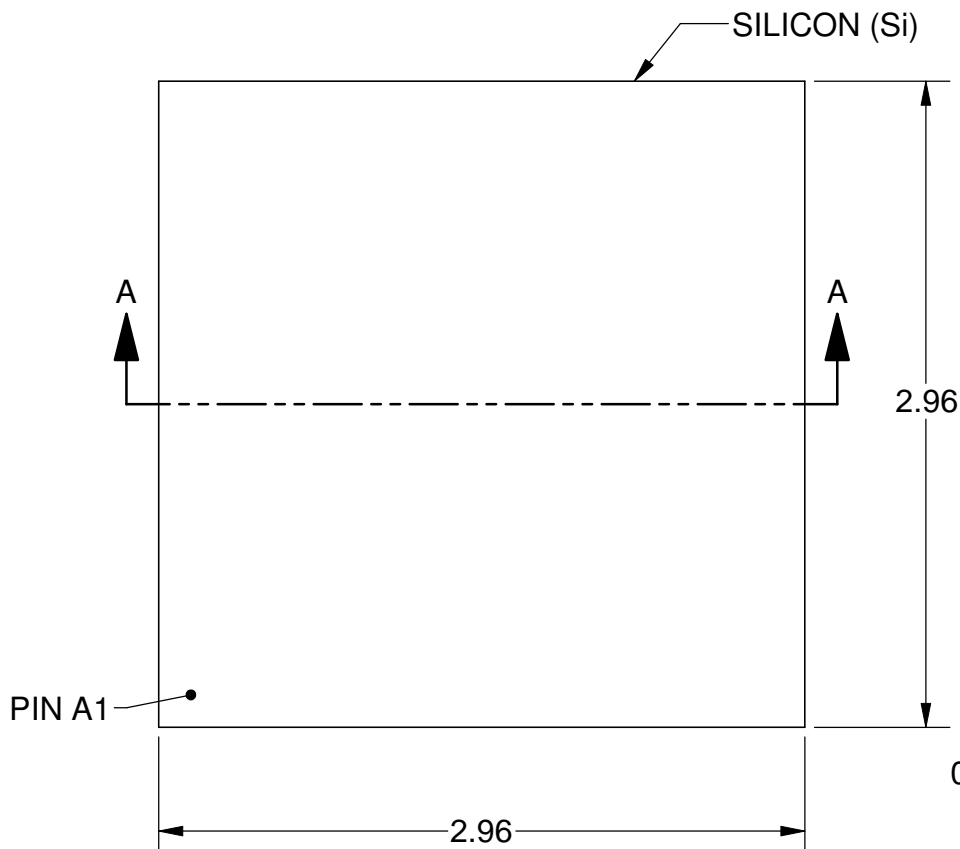
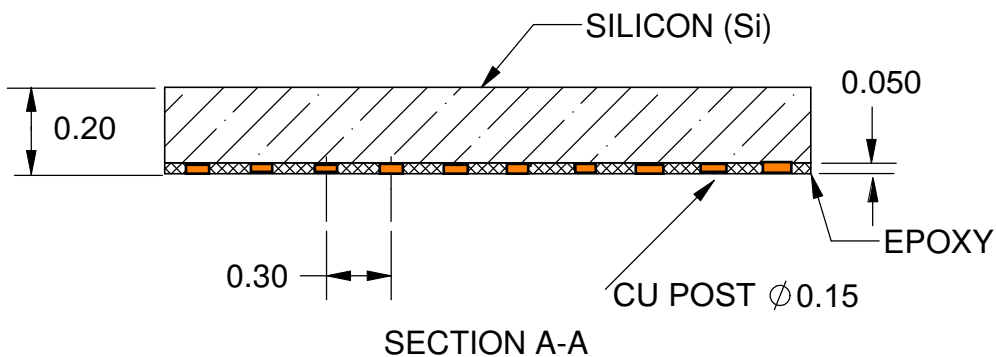
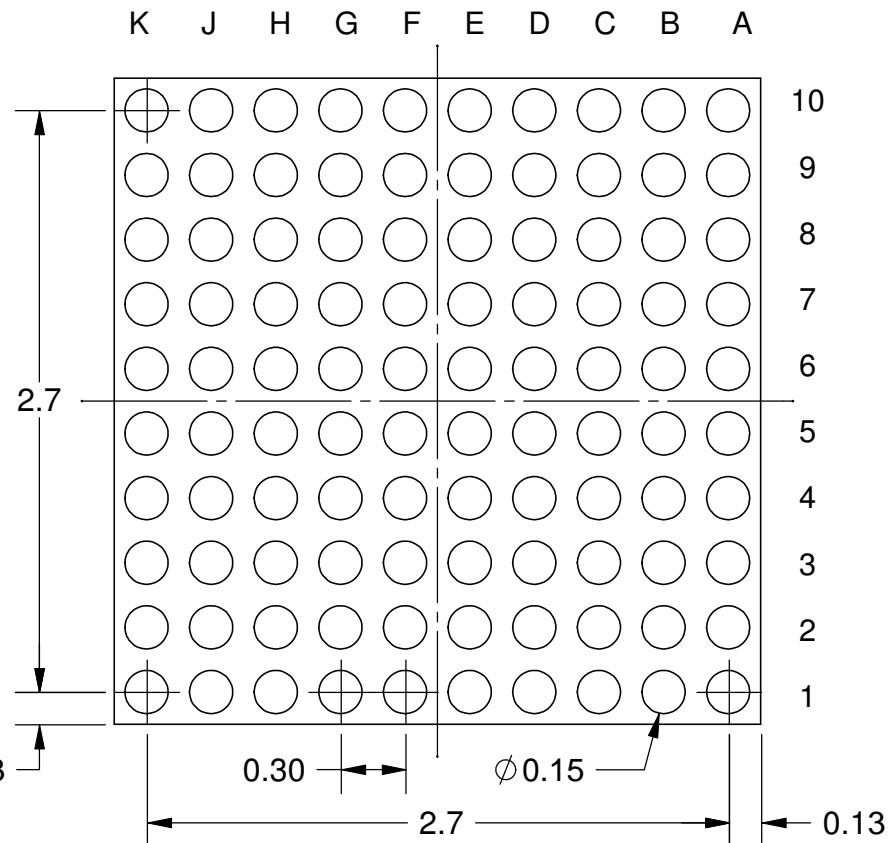



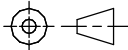
TOP VIEW



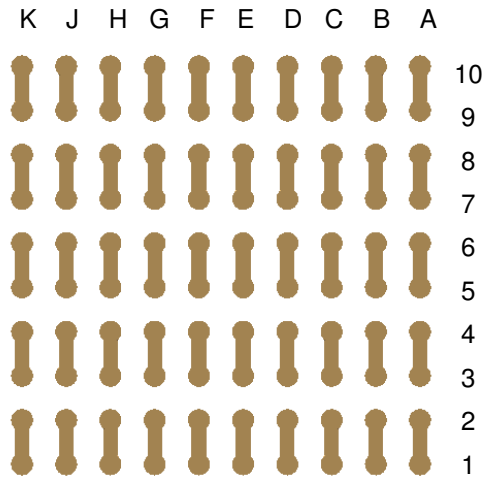
PAD VIEW



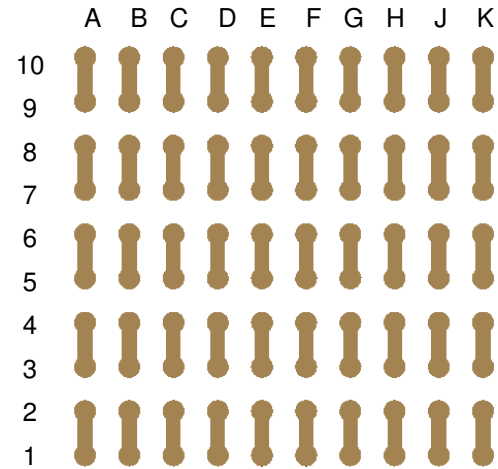
- Notes: (Unless Otherwise Specified).  
 1) ALL DIMENSIONS ARE IN MM.  
 2) PAD ALLOY: Cu Post (50um Thick)  
 3) PAD Cu DIAMETER: 0.15mm.  
 4) DIE MATERIAL: Si (SILICON).  
 5) DAISY CHAIN PATTERN (SEE PAGE 2).

TOLERANCE UNLESS NOTED		APPROVALS		DATE				
X.X	+/- 0.3	DRAWN J. Hines		12/29/2010				
X.XX	+/- 0.03	ENG			100-L P=0.3mm (TEG0306)			
X.XXX	+/- 0.003	MFG			SCALE 28.5:1	SIZE A	DRAWING NO. 631080	REV A
ALL DIMENSIONS IN		THIRD ANGLE PROJECTION			DO NOT SCALE DRAWING			
<input type="checkbox"/> INCHES <input checked="" type="checkbox"/> MILLIMETERS				REVISED	SHEET 1 OF 2			

BALL VIEW

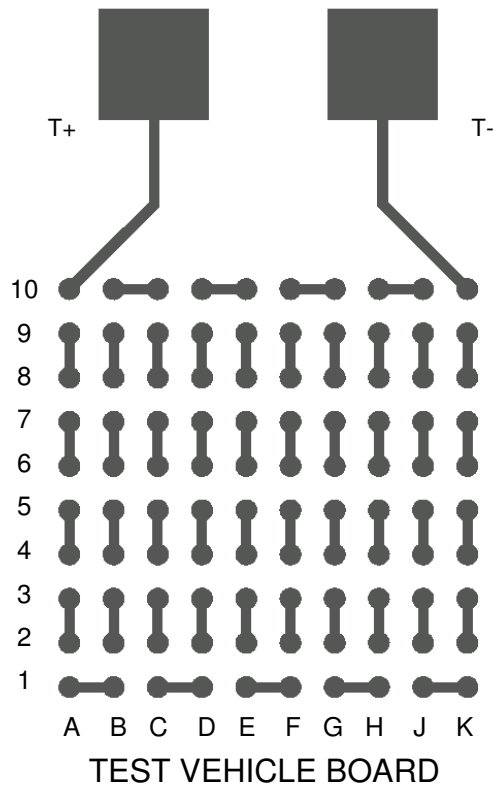


DAISY CHAIN PATTERN

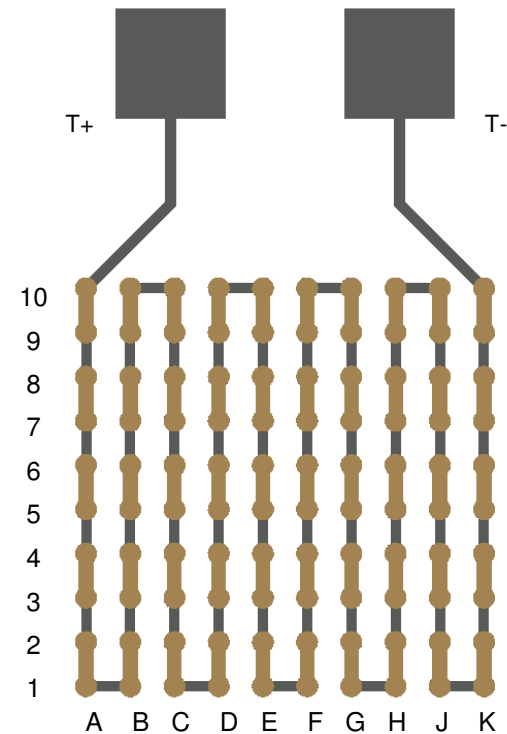


BOTTOM SIDE  
(TOP X-RAY VIEW)

TOP VIEW



AFTER MOUNTING  
TO TEST BOARD  
(TOP X-RAY VIEW)



TEST VEHICLE BOARD

Notes:

- 1) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE. DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.

<b>TopLine</b> ®			
TITLE eWLP100T.3-DC108D 100-L P=0.3mm (TEG0306)			
SCALE 19.5:1	SIZE A	DRAWING NO. 631080	REV A
DO NOT SCALE DRAWING		SHEET 2 OF 2	